CORRECTION

Correction to: Effect of the WC Composition Ratio on the Microstructure and Properties of WC-10Ni+AgCuTi Coatings

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/ Published online: 7 February 2022

Correction to: JMEPEG

<https://doi.org/10.1007/s11665-022-06581-2>

In this published article, the corresponding author was identified incorrectly, and an affiliation was omitted. The corresponding author is Chunzhi Xia, and the correct list of affiliations is shown below:

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The original article can be found online at <https://doi.org/10.1007/s11665-022-06581-2>.

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